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A study of AlN-Si₃N₄ codeposits using the L.P.C.V.D. technique

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ABSTRACT:

We have studied the codeposition of aluminum nitride and silicon nitride, using aluminum trichloride and silicon tetrachloride as vectors of aluminum and silicon respectively, ammonia as source of nitrogen, and nitrogen as carrier gas. A preliminary thermodynamic study allowed us to determine the influence of pressure, temperature and gas composition on the Al, Si, N, H, Cl system. Particularly, we have shown that the Al/Si ratio as well as the quantity of ammonia play a crucial role in the composition of the codeposit. An experimental study has been carried out using a hot-wall reactor. At 1253 K with a pressure of 133 Pa, we have obtained deposits varying from AlN to Si₃N₄, via intermediate compositions, by varying the reactive gas mixture. The codeposits have been characterized using various methods such as X-ray diffraction, Auger, X.P.S., S.E.M. and E.P.M.A..

1. INTRODUCTION

For many years the aluminum and silicon nitrides have presented great interest as ceramic materials for high temperature and electronic applications.

AlN and Si₃N₄ are often used in thin solid films on electronic devices [1,2].

Among the thin coating methods for these materials, the low pressure chemical vapour deposition (L.P.C.V.D.) is one of the most attractive [3,4].

Our laboratory has more than twenty years of experience in the field of L.P.C.V.D. and particularly on the vapour deposition of AlN and Si₃N₄ [5,6].

In the aim of having materials with new properties such as a better oxidation resistance than either AlN or Si₃N₄ taken separately, we have thought to make codeposits, and we have entered upon a study of the Al-Si-N system.

In the literature, few works have been already done on this system.

HILLERT and al. [7] have done an interesting theoretical work on the Al-Si-N system considering the pseudo binary Si₃N₄-AlN.

A more general study on the ternary systems M-Si-N (with M = Al, Cu, Zn...) was done by WEITZER and al [8]. Their results suggest that no ternary phase is present in the Al-Si-N system, neither a

solid solution.

From the experimental point of view, ZIRINSKY and al. [9] reported previously other results concerning the mixed deposition of aluminum and silicon nitrides on silicon and sapphire substrates between 600 and 1100°C by ammoniolytic of aluminum trichloride and silane. These authors showed that the deposit kinetics and the thickness uniformity is influenced by the ratio $\text{NH}_3/(\text{AlCl}_3, \text{SiCl}_4)$, but no thermodynamic approach was made.

Our contribution consists in doing first a thermodynamic predictive calculation, and secondly an experimental study with a characterization of the vapour deposited coatings.

We propose the synthesis of these two compounds AlN and Si_3N_4 using chemical vapor deposition with aluminum trichloride, silicon tetrachloride, ammonia and hydrogen as chemical precursors.

2. THERMODYNAMIC STUDY

Before an experimental elaboration of such materials, it is necessary to do a theoretical calculation to know the better conditions for AlN and Si_3N_4 codeposits.

The equilibrium calculation is based upon the Gibbs free energy minimization method in a closed system. We use the SOLGASMIX program, developed by ERIKSSON [10] which calculates both vapour and solid phase compositions when equilibrium is reached at given temperature and total pressure.

For this system, the variance is equal to 3. So when P and T are fixed, the degree of freedom is one, so we have to fix, for example, a composition ratio.

The deposit is considered as being in equilibrium with the vapour phase. It is also assumed that the substrate is chemically inert with respect to the deposit and the vapour phase, and that all the chemical species which can be present at the equilibrium are known and taken into account in the calculations.

With our precursors, we consider the system Al , Si , Cl , and H . Thus 38 species are taken (Table 1).

The thermodynamic data used for the calculation are taken from JANAF tables [11].

The domain of investigation is restricted to : $2.5 \cdot 10^{-2} \leq \text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4) \leq 4.10^2$, $1100 \leq T \leq 1500 \text{ K}$ and $100 \leq P_t \leq 10^4 \text{ Pa}$.

The chemical species initially introduced into the calculations either react totally at equilibrium to give new species or remain partially unreacted.

The results are formulated as thermodynamic yield (Y_x) defined as the ratio between the input mole number of species x (X_{in}) to the mole number of the parent species at equilibrium (X_{eq}) taking into account the stoichiometric coefficient. For example:

$$Y_{\text{AlN}} = \text{AlN}_{eq} / \text{AlCl}_{3in}$$

$$Y_{\text{Si}_3\text{N}_4} = 3 \text{ Si}_3\text{N}_{4eq} / \text{SiCl}_{4in}$$

$$Y_{\text{HCl}} = \text{HCl}_{eq} / 7(\text{AlCl}_3 + \text{SiCl}_4)_{in}$$

2.1 Yields variation with temperature

The variations of the AlN and Si_3N_4 yields with temperature are shown on Figures 1 and 2 for a maximum final mixing of 75% AlN + 25% Si_3N_4 for two pressures : 500 and 10^4 Pa .

In both cases, $Y_{\text{Si}_3\text{N}_4} = 100\%$ when the molar ratio $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4)$ value is in the range 20-160. However, Y_{AlN} decreases with decreasing the last ratio.

This behaviour is amplified by decreasing the pressure. Indeed, on Figure 2 ($P = 500$ Pa), for temperatures upper than 1400°C , the AlN yield is nearly zero.

2.2 Yields variation with the molar ratio $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4)$

On Figures 3 and 4, the AlN and Si_3N_4 yields are given versus the molar ratio $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4)$ for a total pressure of 10^4 Pa and for two temperatures of 1300 and 1500 K.

At this pressure, whatever is the temperature, the AlN formation only appears for a molar ratio upper than 20 as the Si_3N_4 one starts at 0.050.

Moreover, the AlN formation only starts when nearly all the Si_3N_4 is formed.

For the lower pressure of 500 Pa, Figures 5 (for 1300 K) and 6 (for 1400 K) show the same tendency, but the formation of AlN is never complete and for 1500 K, there is no AlN elaborated.

We can see that when the AlN yield decreases the AlCl yield is very high.

In conclusion, this thermodynamic study shows that it is necessary to have a great molar ratio $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4)$ to prepare AlN and Si_3N_4 whatever are the pressure and temperature constraints.

3. EXPERIMENTAL STUDY

The experimental system used is a vertical hot wall reactor composed of a graphite susceptor heated by high frequency induction. Source gases were aluminum trichloride AlCl_3 , silicon tetrachloride SiCl_4 , ammonia NH_3 and nitrogen N_2 as a carrier gas. The AlCl_3 contained in an evaporator, was heated by a wire heater and carried by nitrogen. The SiCl_4 contained in another evaporator is heated at 313 K (vapour pressure $\sim 54 \cdot 10^3$ Pa). All gas connections were thermally insulated to prevent any condensation. The ammonia was injected separately from the other reactive gases to avoid a reaction between them before the reaction zone. A graphite sample protected by a $\beta\text{-SiC}$ layer deposited by L.P.C.V.D. was used as substrate.

The deposition was tried using the following conditions: temperature 1253 K to 1373 K, pressure 133 Pa; gas phase composition $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4) = 1$ to 60; N_2 flowrate $D = 8 \cdot 10^3 \text{ cm}^3 \cdot \text{h}^{-1}$.

Codeposits characterization

The chemical compositions of the codeposits were first determined by an Electron Probe Micro-Analysis (E.P.M.A.) CAMECA using Wavelength Dispersive System (W.D.S.). Various compositions of the codeposits were evidenced in all the pseudo-binary composite range between pure AlN and pure Si_3N_4 . The codeposits contain only some traces of chlorine and less than 2% atomic of oxygen and carbon. These low carbon and oxygen amounts can be attributed to surface contamination, or to some porosity.

The codeposits obtained at 1253 K were analyzed by X-Ray Diffraction. For the materials with very low silicon contents (1 to 2%) the X.R.D. spectra present narrow diffraction peaks corresponding to a crystallized AlN phase. Nevertheless, the X.R.D. peaks are broadened with increasing the silicon content in the deposits. For Si contents higher than 15% atomic concentration, the X.R.D. spectra are similar to those of amorphous compounds.

The surface morphology of the deposits has been examined by Scanning Electron Microscopy (S.E.M.) : the codeposits with high AlN content present a polycrystalline structure with well defined

microcrystals (Fig.7), which agrees with the characteristic growth of AlN from AlCl_3 and NH_3 gas precursors [12]. A morphological change is observed with increasing the silicon content in the codeposit. Indeed, the sharp edges observed for pure AlN disappear progressively with increasing the silicon content in the solid. Progressively, the surface acquires a "cauliflower" aspect (Fig.8). Polished cross section show that the codeposit has a good adhesion on the silicon carbide substrate (Fig.9).

An $\text{AlN-Si}_3\text{N}_4$ codeposit (Al : 22%, Si : 24%, N : 53.6% , O : 0.4%) has been characterized by X-Ray Photoelectron Spectroscopy (X.P.S.) using a CAMECA RIBER AUGER X.P.S. device.

Charging effects involving charge shift were observed on this insulating material. However, chemical bondings informations could be obtained by measuring the modified Auger parameter α' for silicon and for aluminum.

The Auger parameter α' is the difference between the Si KLL (or Al KLL) line kinetic energy and the Si 2p (or Al 2p) photoelectron line kinetic energy, plus the energy of the Al K α exciting radiation.

$$\alpha' = E_k(\text{Si KLL}) - E_k(\text{Si 2p}) + 1486.6 \text{ eV}$$

This parameter is not subject to steady charge effects.

The X.P.S. spectrum obtained for this codeposit is shown on Figure 10.

The α' values measured for Si and Al are the following ones :

$$\alpha'(\text{Si}) = 1714.6 \pm 0.2 \text{ eV}, \alpha'(\text{Al}) = 1463 \pm 0.2 \text{ eV}.$$

For Si_3N_4 , some authors reported the α' values :

$$1714.1 \text{ eV [13] and } 1714.6 \text{ eV [14].}$$

Two reference Si_3N_4 samples were examined in this work. We obtained :

$$\alpha'(\text{Si}) = 1714.6 \pm 0.2 \text{ eV}.$$

For AlN, the α' value given elsewhere is :

$$\alpha' = 1462.9 \text{ eV}.$$

The Auger parameters measured for the Al-Si-N codeposit match very well the Auger parameters measured for AlN and Si_3N_4 compounds. Therefore, we could conclude that this codeposit is presumably an $\text{AlN-Si}_3\text{N}_4$ mixture.

4. CONCLUSION

The thermodynamical study reported in this work has demonstrated that the formation of $\text{AlN-Si}_3\text{N}_4$ codeposits requires high molar ratios $\text{NH}_3/(\text{AlCl}_3 + \text{SiCl}_4)$.

Then, an experimental $\text{AlN-Si}_3\text{N}_4$ codeposition trial in a CVD hot-wall reactor demonstrated the formation of these codeposits in all the composition range between pure AlN and pure Si_3N_4 . The W.D.S. and X.P.S. characterizations of one deposit containing equal amounts of aluminum and silicon resulted in the conclusion that these codeposits contain AlN and Si_3N_4 mixtures.

This paper reports a preliminary experimental study of the Al-Si-N codeposits elaboration by L.P.C.V.D. We would investigate now the influence of various experimental conditions on the composition

and on the microstructures of the codeposits.

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Table 1 : Chemical species introduced in the thermodynamic calculations (<> solid, // liquid, gas).

System Al - Si - Cl - H - N (* reference state)							
Al	AlH	AlN	N	N ₂ H ₄	SiH ₂ Cl ₂	/Al/*	
Al ₂	Cl		Si	N ₂ *	SiCl	SiHCl ₃	<Si>
AlCl	Cl ₂ *		Si ₂	NH	SiCl ₂	SiH	<AlN>
AlCl ₂	HCl		Si ₃	NH ₂	SiCl ₃	SiH ₄	<Si ₃ N ₄ >
AlCl ₃	H		SiN	NH ₃	SiCl ₄		
Al ₂ Cl ₆	H ₂ *		Si ₂ N	N ₂ H ₂	SiH ₃ Cl

Figure 1: Si_3N_4 and AlN yields versus temperature, with $P = 10^4 \text{ Pa}$, for six molar ratios $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$.

Figure 2: Si_3N_4 and AlN yields versus temperature, with $P = 500 \text{ Pa}$, for six molar ratios $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$.

Figure 3: Equilibrium yields variation versus the molar ratio $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$, with $T = 1300 \text{ K}$ and $P = 10^4 \text{ Pa}$.

Figure 4: Equilibrium yields variation versus the molar ratio $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$, with $T = 1500 \text{ K}$ and $P = 10^4 \text{ Pa}$.

Figure 5: Equilibrium yields variation versus the molar ratio $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$, with $T = 1300 \text{ K}$ and $P = 500 \text{ Pa}$.

Figure 6: Equilibrium yields variation versus of the molar ratio $\text{NH}_3 / (\text{AlCl}_3 + \text{SiCl}_4)$, with $T = 1400 \text{ K}$ and $P = 500 \text{ Pa}$.

Figure 7.

Figure 8.

Figure 9.

Figure 7: SEM micrograph showing the morphology of 95% AlN and 5% Si_3N_4 .

Figure 8: SEM micrograph showing the morphology of 95% Si_3N_4 and 5% AlN.

Figure 9: SEM micrograph showing a cross-section of the AlN- Si_3N_4 codeposit (95% AlN and 5% Si_3N_4).

Figure 10 : X.P.S. spectrum obtained on experimental conditions :
 $T = 1253 \text{ K}$, $P = 133 \text{ Pa}$.